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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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ON Semiconductor®

SuperFET[®] III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior

switching performance, and withstand extreme dv/dt rate.

Consequently, SuperFET III MOSFET is very suitable for

various power system for miniaturization and higher efficiency.



$\begin{array}{l} \textbf{FCPF250N65S3L1} \\ \textbf{N-Channel SuperFET}^{\texttt{R}} \textbf{III MOSFET} \\ \textbf{650 V, 12 A, 250 m} \Omega \end{array}$

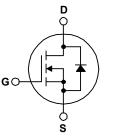
Features

- 700 V @ T_J = 150 ^oC
- Typ. R_{DS(on)} = 210 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 24 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 248 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies





Description

Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

	$ \begin{array}{c} - \text{DC} \\ \hline - \text{AC} \\ - \text{Continuous } (\text{T}_{\text{C}} = 25^{\circ}\text{C} \\ \hline - \text{Continuous } (\text{T}_{\text{C}} = 100^{\circ} \\ \hline - \text{Pulsed} \\ \end{array} $,	650 ±30 ±20 12* 7.6* 30* 57	V V V A A	
urrent urrent Pulsed Avalanche Ene	- AC - Continuous ($T_C = 25^{\circ}C$ - Continuous ($T_C = 100^{\circ}C$ - Pulsed	C) C) (Note 1)	±30 12* 7.6* 30*	V - A	
urrent urrent Pulsed Avalanche Ene	- Continuous ($T_C = 25^{\circ}C$ - Continuous ($T_C = 100^{\circ}C$ - Pulsed	C) C) (Note 1)	12* 7.6* 30*	- A	
urrent Pulsed Avalanche Ene	- Continuous (T _C = 100 ^c - Pulsed	(Note 1)	7.6* 30*		
urrent Pulsed Avalanche Ene	- Pulsed	(Note 1)	30*		
Pulsed Avalanche Ene		, ,		А	
	ergy	(Note 2)	F7		
sho Curront		Single Pulsed Avalanche Energy (Note 2)			
Avalanche Current (Note 1)			2.3	А	
Repetitive Avalanche Energy (Note 1)			0.31	mJ	
MOSFET dv/dt			100	V/ns	
Peak Diode Recovery dv/dt (Note 3)				v/ns	
Dissingtion	(T _C = 25 ^o C)		31	W	
Jissipation	- Derate Above 25°C		0.25	W/ºC	
Operating and Storage Temperature Range			-55 to +150	°C	
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	
	Im Lead Temperature	Dissipation - Derate Above 25°C - Derate Above 25°C - Derate Above 25°C	Dissipation - Derate Above 25°C ng and Storage Temperature Range Im Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	Dissipation - Derate Above 25°C 0.25 ng and Storage Temperature Range -55 to +150	

Thermal Characteristics

Symbol	Parameter	FCPF250N65S3L1	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	4.07	0C/M	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	

FCPF250N65S3L1
- N-Channel Supe
rFET®
III MOSFET

•		Top Mark	Package	e Packing Method Reel Siz		е	Tape Width	n Qu	Quantity	
		TO-220F				N/A	50	50 units		
Electrica	l Chara	cteristics To = 25	^o C unless oth	perwise noted		1				
Symbol	Parameter			Test Conditions			Тур.	Max.	Unit	
Off Charao	cteristics									
BV _{DSS}	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C			-	-	V	
200	Diamito ot	<u> </u>		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C		700	-	-	V	
∆BV _{DSS} / ∆T _J	Breakdown Voltage Temperature Coefficient		_	$I_D = 1 \text{ mA}$, Referenced to $25^{\circ}C$			0.67	-	V/ºC	
l	Zero Gate Voltage Drain Current		VD	$V_{DS} = 650 V, V_{GS} = 0 V$ $V_{DS} = 520 V, T_C = 125^{\circ}C$		-	-	1	μA	
DSS			VD			-	0.77	-	μΛ	
I _{GSS}	Gate to Body Leakage Current		V _G	$_{\rm S}$ = ±30 V, V _{DS} = 0 V		-	-	±100	nA	
On Charac	cteristics									
V _{GS(th)}	Gate Three	shold Voltage	VG	_{SS} = V _{DS} , I _D = 1.2 mA		2.5	-	4.5	V	
R _{DS(on)}		n to Source On Resista		_{is} = 10 V, I _D = 6 A		-	210	250	mΩ	
9FS	Forward T	ransconductance	VD	_{os} = 20 V, I _D = 6 A		-	7.4	-	S	
Ovnamic (Characteri	stics								
C _{iss}	Input Capa		Vn	_{os} = 400 V, V _{GS} = 0 V,		-	1010	-	pF	
C _{oss}	Output Ca	pacitance		1 MHz		-	25	-	pF	
C _{oss(eff.)}	Effective C	output Capacitance	VD	$_{\rm OS}$ = 0 V to 400 V, V _{GS}	= 0 V	-	248	-	pF	
C _{oss(er.)}	Energy Re	lated Output Capacitar		$_{\rm OS}$ = 0 V to 400 V, V _{GS}		-	33	-	pF	
Q _{g(tot)}	Total Gate	Charge at 10V	VD	_{os} = 400 V, I _D = 6 A,		-	24	-	nC	
Q _{gs}	Gate to So	urce Gate Charge		_{SS} = 10 V		-	6.1	-	nC	
Q _{gd}	Gate to Dr	ain "Miller" Charge			(Note 4)	-	9.7	-	nC	
ESR	Equivalent	Series Resistance	f =	1 MHz		-	8.7	-	Ω	
Switching	Characte	ristics								
d(on)	Turn-On D	elay Time				-	18	-	ns	
r	Turn-On R	ise Time		V_{DD} = 400 V, I _D = 6 A, V_{GS} = 10 V, R _g = 4.7 Ω (Note 4)		-	18	-	ns	
d(off)	Turn-Off D	elay Time	V _G			-	49	-	ns	
f	Turn-Off Fa	all Time				-	12	-	ns	
Source-Dr	ain Diode	Characteristics	·							
s	Maximum Continuous Drain to Source Diode Forward Current				-	-	12	Α		
I _{SM}	Maximum Pulsed Drain to Source Diode Fo			orward Current		-	-	30	Α	
V _{SD}	Drain to Sc	ource Diode Forward Vo	oltage V _G	_{iS} = 0 V, I _{SD} = 6 A		-	-	1.2	V	
lrr	Reverse R	ecovery Time		$V_{GS} = 0 V, I_{SD} = 6 A,$		-	251	-	ns	
Q _{rr}	Reverse R	ecovery Charge		/dt = 100 A/µs	_	-	3.4	-	μC	
. I _{AS} = 2.3 A, R _G . I _{SD} ≤ 6 A, di/dt	= 25 Ω, starting 1 ≤ 200 A/μs, V _{DD} ≤	ited by maximum junction tem; ⁻」 = 25°C. ≨ 400 V, starting T」 = 25°C. ting temperature typical chara								

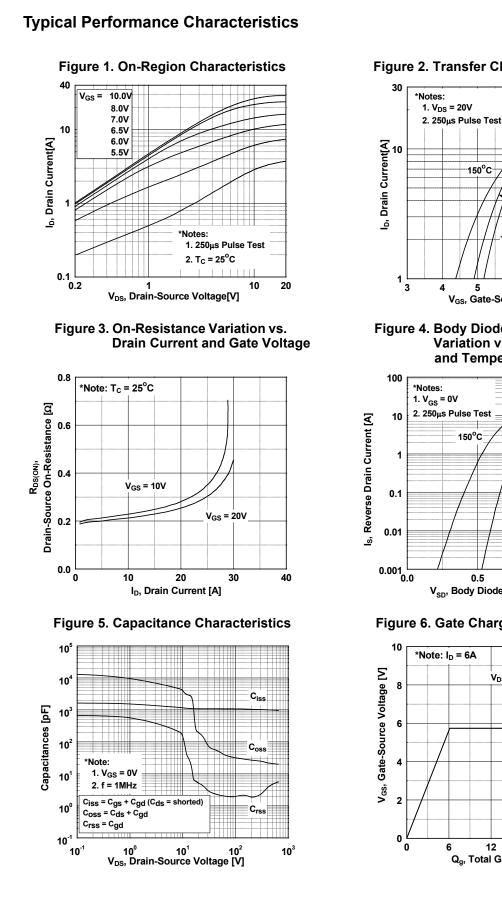
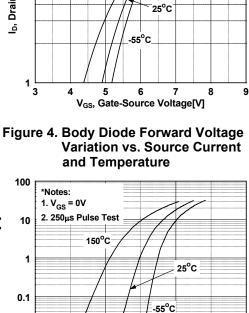
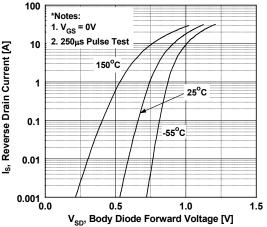
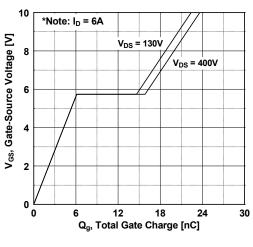


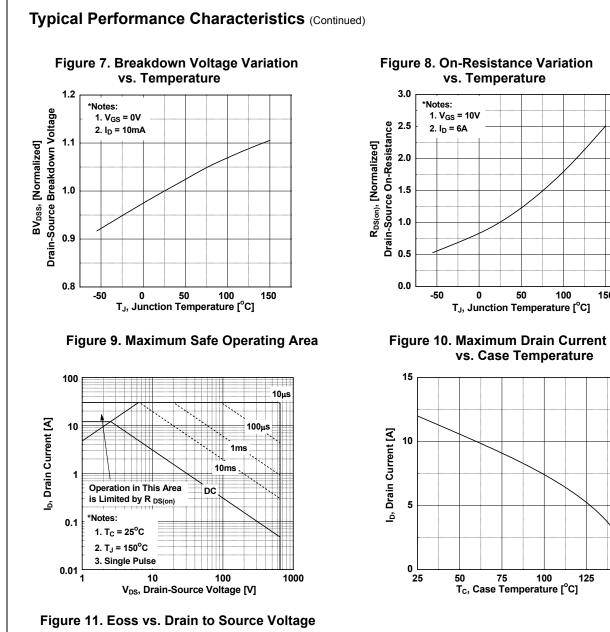
Figure 2. Transfer Characteristics

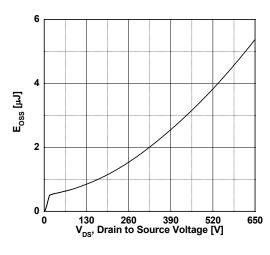




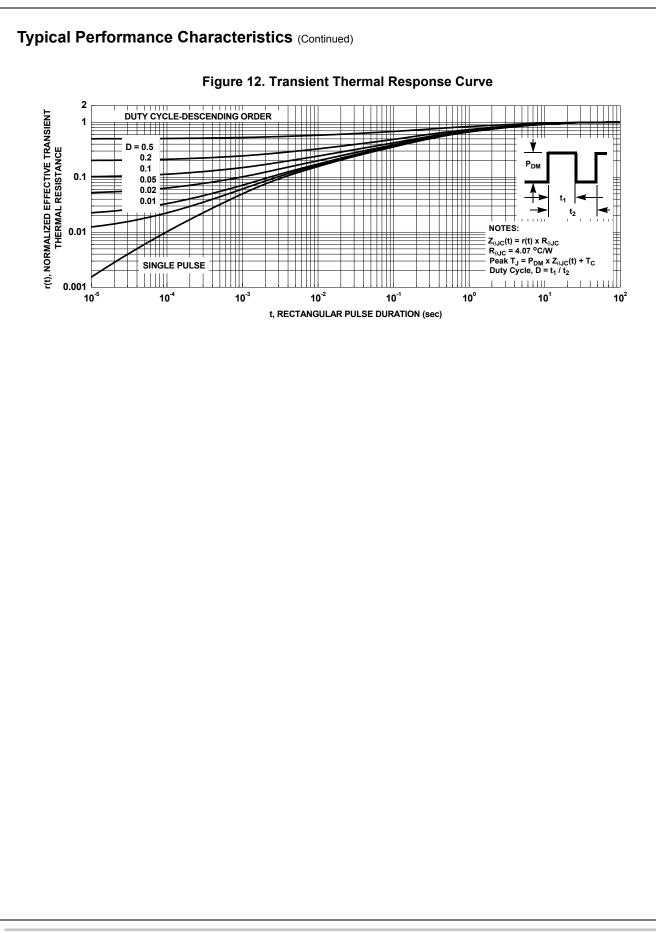


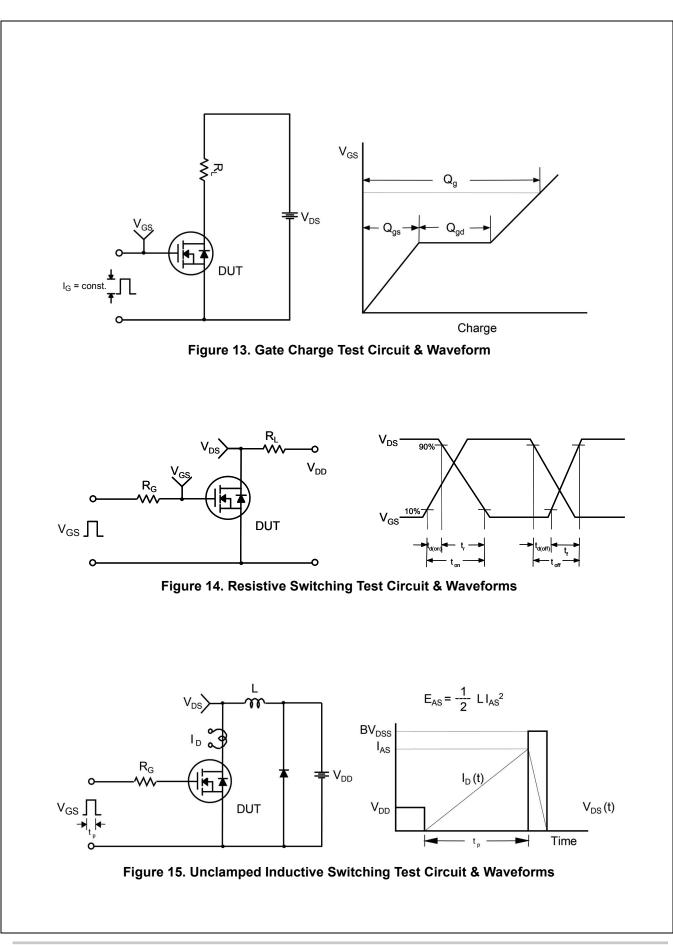






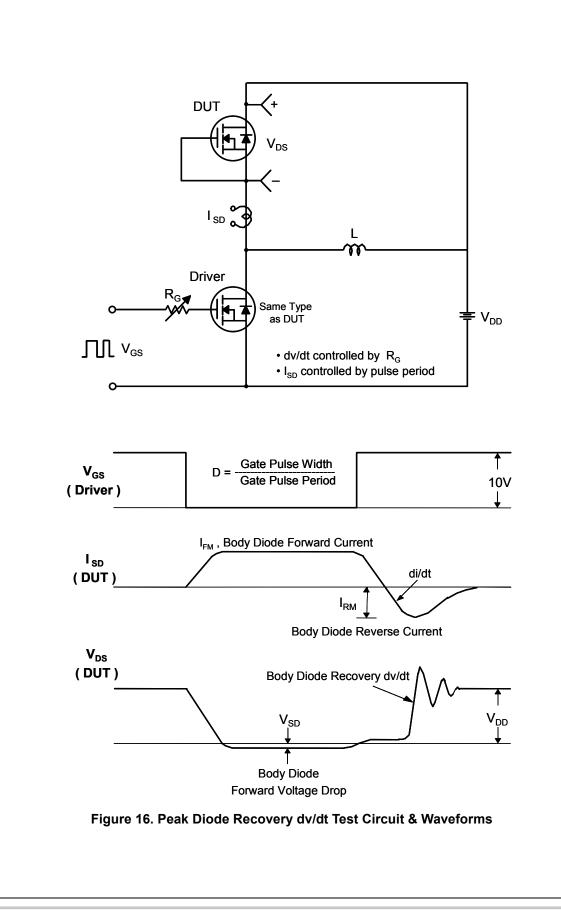
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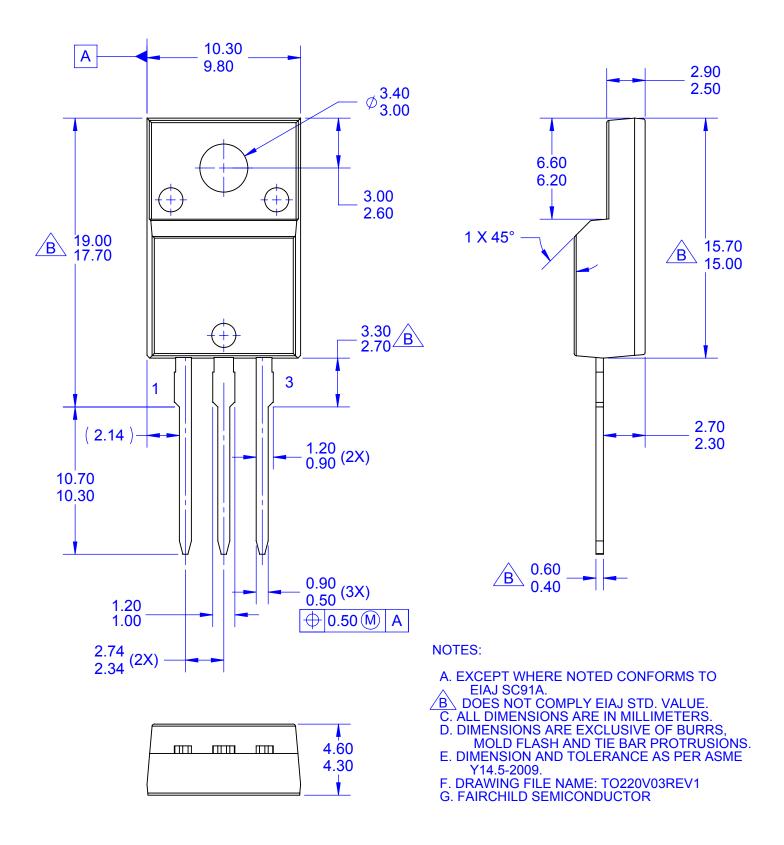




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